# 0.37 GHz to 6.39 GHz Integer-N Synthesizer with Integrated VCO 

## feATURES

- Low Noise Integer-N PLL with Integrated VCO
- $-226 \mathrm{dBc} / \mathrm{Hz}$ Normalized In-Band Phase Noise Floor
- $-274 \mathrm{dBc} / \mathrm{Hz}$ Normalized In-Band 1/f Noise
- -157dBc/Hz Wideband Output Phase Noise Floor
- Excellent Spurious Performance
- Output Divider (1 to 6, 50\% Duty Cycle)
- Output Buffer Muting
- Low Noise Reference Buffer
- Charge Pump Current Adjustable from $250 \mu \mathrm{~A}$ to 11.2 mA
- Configurable Status Output
- SPI Compatible Serial Port Control
- PLLWizard ${ }^{\text {TM }}$ Software Design Tool Support


## APPLICATIONS

- Wireless Base Stations (LTE, WiMAX, W-CDMA, PCS)
- Broadband Wireless Access
- Military and Secure Radio
- Test and Measurement
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## DESCRIPTION

The LTC®6946 is a high performance, low noise, 6.39 GHz phase-locked loop (PLL) with a fully integrated VCO, including a reference divider, phase-frequency detector (PFD) with phase-lock indicator, ultralow noise charge pump, integer feedback divider, and VCO output divider. The charge pump contains selectable high and low voltage clamps useful for VCO monitoring.
The integrated low noiseVCO uses no external components. It is internally calibrated to the correct output frequency with no external system support.
The part features a buffered, programmable VCO output divider with a range of 1 through 6 , providing a wide frequency range.

Frequency Coverage Options

|  | LTC6946-1 | LTC6946-2 | LTC6946-3 | LTC6946-4 |
| :---: | :---: | :---: | :---: | :---: |
| 0 DIV=1 | 2.240 to 3.740 | 3.080 to 4.910 | 3.840 to 5.790 | 4.200 to 6.390 |
| 0 DIV=2 | 1.120 to 1.870 | 1.540 to 2.455 | 1.920 to 2.895 | 2.100 to 3.195 |
| 0 DIV=3 | 0.747 to 1.247 | 1.027 to 1.637 | 1.280 to 1.930 | 1.400 to 2.130 |
| O DIV=4 | 0.560 to 0.935 | 0.770 to 1.228 | 0.960 to 1.448 | 1.050 to 1.598 |
| O DIV=5 | 0.448 to 0.748 | 0.616 to 0.982 | 0.768 to 1.158 | 0.840 to 1.278 |
| 0 DIV=6 | 0.373 to 0.623 | 0.513 to 0.818 | 0.640 to 0.965 | 0.700 to 1.065 |

## TYPICAL APPLICATION

### 5.7GHz Wideband Receiver



LTC6946-3 PLL Phase Noise
ABSOLUTE MAXIMUM RATINGS
(Note 1)
Supply Voltages
$\mathrm{V}^{+}\left(\mathrm{V}_{\text {REF }}{ }^{+}, \mathrm{V}_{\text {REFO }}{ }^{+}, \mathrm{V}_{\mathrm{RF}}{ }^{+}, \mathrm{V}_{\mathrm{D}}{ }^{+}\right)$to GND ..... 3.6V
$\mathrm{V}_{\mathrm{CP}}{ }^{+}, \mathrm{V}_{\mathrm{VCO}}{ }^{+}$to GND ..... 5.5V
Voltage on CP Pin

$\qquad$
GND - 0.3V to $\mathrm{V}_{\mathrm{CP}}{ }^{+}+0.3 \mathrm{~V}$
Voltage on All Other Pins

$\qquad$
GND -0.3 V to $\mathrm{V}^{+}+0.3 \mathrm{~V}$
Operating Junction Temperature Range, $\mathrm{T}_{\mathrm{J}}$ (Note 2)LTC6946I
$\qquad$ $-40^{\circ} \mathrm{C}$ to $105^{\circ} \mathrm{C}$Storage Temperature Range$-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$

## PIn CONFIGURATIOn



28-LEAD ( $4 \mathrm{~mm} \times 5 \mathrm{~mm}$ ) PLASTIC QFN
$T_{\text {JMAX }}=125^{\circ} \mathrm{C}, \theta_{\mathrm{Jcbottom}}=3^{\circ} \mathrm{C} / \mathrm{W}, \theta_{\text {Jctop }}=26^{\circ} \mathrm{C} / \mathrm{W}$
EXPOSED PAD (PIN 29) IS GND, MUST BE SOLDERED TO PCB

## ORDER INFORMATION

| LEAD FREE FINISH | TAPE AND REEL | PART MARKING | PACKAGE DESCRIPTION | JUNCTION TEMPERATURE RANGE |
| :--- | :--- | :--- | :--- | :--- |
| LTC6946IUFD-1\#PBF | LTC6946IUFD-1\#TRPBF | 69461 | 28 -Lead $(4 \mathrm{~mm} \times 5 \mathrm{~mm})$ Plastic QFN | $-40^{\circ} \mathrm{C}$ to $105^{\circ} \mathrm{C}$ |
| LTC6946IUFD-2\#PBF | LTC6946IUFD-2\#TRPBF | 69462 | 28 -Lead $(4 \mathrm{~mm} \times 5 \mathrm{~mm})$ Plastic QFN | $-40^{\circ} \mathrm{C}$ to $105^{\circ} \mathrm{C}$ |
| LTC6946IUFD-3\#PBF | LTC6946IUFD-3\#TRPBF | 69463 | 28 -Lead $(4 \mathrm{~mm} \times 5 \mathrm{~mm})$ Plastic QFN | $-40^{\circ} \mathrm{C}$ to $105^{\circ} \mathrm{C}$ |
| LTC6946IUFD-4\#PBF | LTC6946IUFD-4\#TRPBF | 69464 | 28 -Lead $(4 \mathrm{~mm} \times 5 \mathrm{~mm})$ Plastic QFN | $-40^{\circ} \mathrm{C}$ to $105^{\circ} \mathrm{C}$ |

Consult LTC Marketing for parts specified with wider operating temperature ranges.
Consult LTC Marketing for information on non-standard lead based finish parts.
For more information on lead free part marking, go to: http://www.linear.com/leadfree/
For more information on tape and reel specifications, go to: http://www.linear.com/tapeandreel/

## AVAILABLE OPTIONS

| VCO FREQUENCY RANGE (GHz) | PACKAGE STYLE | OUTPUT FREQUENCY RANGE vs OUTPUT DIVIDER SETTING (GHz) |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | QFN-28 (UFD28) | 0 DIV = 6 | 0 DIV = 5 | 0 DIV = 4 | 0 DIV = 3 | $0 \mathrm{DIV}=2$ | 0 DIV = 1 |
| 2.240 to 3.740 | LTC6946IUFD-1 | 0.373 to 0.623 | 0.448 to 0.748 | 0.560 to 0.935 | 0.747 to 1.247 | 1.120 to 1.870 | 2.240 to 3.740 |
| 3.080 to 4.910 | LTC6946IUFD-2 | 0.513 to 0.818 | 0.616 to 0.982 | 0.770 to 1.228 | 1.027 to 1.637 | 1.540 to 2.455 | 3.080 to 4.910 |
| 3.840 to 5.790 | LTC6946IUFD-3 | 0.640 to 0.965 | 0.768 to 1.158 | 0.960 to 1.448 | 1.280 to 1.930 | 1.920 to 2.895 | 3.840 to 5.790 |
| 4.200 to 6.390 | LTC6946IUFD-4 | 0.700 to 1.065 | 0.840 to 1.278 | 1.050 to 1.598 | 1.400 to 2.130 | 2.100 to 3.195 | 4.200 to 6.390 |
|  |  | Overlapping Frequency Bands |  |  |  |  |  |

## ELECARICRL CHARACTERISTICS The $\bullet$ denotes the specifications which apply over the full operating

 junction temperature range, otherwise specifications are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C} . \mathrm{V}_{\mathrm{REF}}{ }^{+}=\mathrm{V}_{\mathrm{REFO}}{ }^{+}=\mathrm{V}_{\mathrm{D}}{ }^{+}=\mathrm{V}_{\mathrm{RF}^{+}}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{CP}^{+}}=\mathrm{V}_{\mathrm{VCO}^{+}}=5 \mathrm{~V}$ unless otherwise specified (Note 2). All voltages are with respect to GND.| SYMBOL | PARAMETER | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Reference Inputs ( $\mathrm{REF}^{+}$, $\mathrm{REF}^{-}$) |  |  |  |  |  |  |  |
| $\mathrm{f}_{\text {REF }}$ | Input Frequency |  | $\bullet$ | 10 |  | 250 | MHz |
| $\mathrm{V}_{\text {REF }}$ | Input Signal Level | Single Ended, 1 $\mu$ F AC-Coupling Capacitors | $\bullet$ | 0.5 | 2 | 2.7 | VP-P |
|  | Input Slew Rate |  | $\bullet$ | 20 |  |  | $\mathrm{V} / \mathrm{\mu s}$ |
|  | Input Duty Cycle |  |  |  | 50 |  | \% |
|  | Self-Bias Voltage |  | $\bullet$ | 1.65 | 1.85 | 2.25 | V |
|  | Input Resistance | Differential | $\bullet$ | 6.2 | 8.4 | 11.6 | k $\Omega$ |
|  | Input Capacitance | Differential |  |  | 3 |  | pF |

Reference Output (REFO)

| $\mathrm{f}_{\text {REFO }}$ | Output Frequency |  | $\bullet$ | 10 | 250 | MHz |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{P}_{\text {REFO }}$ | Output Power | $\mathrm{f}_{\text {REFO }}=10 \mathrm{MHz}, \mathrm{R}_{\text {LOAD }}=50 \Omega$ | $\bullet$ | -0.2 | 3.2 | dBm |
|  | Output Impedance, Disabled |  |  |  |  | $\Omega$ |
| VCO |  |  |  |  |  |  |
| fvco | Frequency Range | LTC6946-1 (Note 3) <br> LTC6946-2 (Note 3) <br> LTC6946-3 (Note 3) <br> LTC6946-4 (Note 3) |  | $\begin{aligned} & 2.24 \\ & 3.08 \\ & 3.84 \\ & 4.20 \end{aligned}$ | $\begin{aligned} & 3.74 \\ & 4.91 \\ & 5.79 \\ & 6.39 \end{aligned}$ | GHz <br> GHz <br> GHz <br> GHz |
| KVco | Tuning Sensitivity | LTC6946-1 (Notes 3, 4) <br> LTC6946-2 (Notes 3, 4) <br> LTC6946-3 (Notes 3, 4) <br> LTC6946-4 (Notes 3, 4) |  |  |  | \%Hz/V <br> \%Hz/V <br> $\% \mathrm{~Hz} / \mathrm{V}$ <br> \%Hz/V |

RF Output ( $\mathrm{RF}^{+}$, RF- ${ }^{-}$)

| $\mathrm{f}_{\text {RF }}$ | Output Frequency |  | $\bullet$ | 0.373 | 6.39 | GHz |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | Output Divider Range | All Integers Included | $\bullet$ | 1 | 6 |  |
|  | Output Duty Cycle |  |  |  | 50 | \% |
|  | Output Resistance | Single Ended, Each Output to $\mathrm{V}_{\text {RF }}{ }^{+}$ | $\bullet$ | 111 | 136159 | $\Omega$ |
|  | Output Common Mode Voltage |  | $\bullet$ | 2.4 | $\mathrm{V}_{\mathrm{RF}}{ }^{+}$ | V |
| $\overline{P_{\text {RF(SE) }}}$ | Output Power, Single Ended, $\mathrm{f}_{\mathrm{RF}}=900 \mathrm{MHz}$ | $\begin{aligned} & \mathrm{RFO}[1: 0]=0, \mathrm{R}_{Z}=50 \Omega, \text { LC Match } \\ & \mathrm{RFO}[1: 0]=1, \mathrm{R}_{Z}=50 \Omega, \text { LC Match } \\ & \mathrm{RFO}[1: 0]=2, \mathrm{R}_{Z}=50 \Omega, \text { LC Match } \\ & \mathrm{RFO}[1: 0]=3, R_{Z}=50 \Omega, \text { LC Match } \\ & \hline \end{aligned}$ | $\stackrel{\bullet}{\bullet}$ | $\begin{aligned} & \hline-9.7 \\ & -6.8 \\ & -3.9 \\ & -1.2 \end{aligned}$ | $\begin{gathered} \hline-6.0 \\ -3.6 \\ -0.4 \\ 2.3 \end{gathered}$ | dBm <br> dBm <br> dBm <br> dBm |
|  | Output Power, Muted | $\begin{aligned} & \mathrm{R}_{\mathrm{Z}}=50 \Omega, \text { Single Ended, } \mathrm{f}_{\mathrm{RF}}=900 \mathrm{MHz}, \\ & 0=2 \text { to } 6 \end{aligned}$ | $\bullet$ |  | -60 | dBm |
|  | Mute Enable Time |  | $\bullet$ |  | 110 | ns |
|  | Mute Disable Time |  | $\bullet$ |  | 170 | ns |

## Phase/Frequency Detector

| $f_{\text {PFD }}$ | Input Frequency |  | $\bullet$ | 100 | MHz |
| :--- | :--- | :--- | :--- | :--- | :--- |

Lock Indicator, Available on the STAT Pin and via the SPI-Accessible Status Register

| tLww | Lock Window Width | LKWIN[1:0] = 0 <br> LKWIN[1:0] = 1 <br> LKWIN[1:0] = 2 <br> LKWIN[1:0] = 3 | $\begin{gathered} 3.0 \\ 10.0 \\ 30.0 \\ 90.0 \end{gathered}$ | ns ns ns ns |
| :---: | :---: | :---: | :---: | :---: |
| tLWHYS | Lock Window Hysteresis | Increase in t Lww Moving from Locked State to Unlocked State | 22 | \% |

## LTC6946

ELECTRICAL CHARACTERISTICS The • denotes the specifications which apply over the full operating junction temperature range, otherwise specifications are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C} . \mathrm{V}_{\mathrm{REF}^{+}}=\mathrm{V}_{\mathrm{REFO}}{ }^{+}=\mathrm{V}_{\mathrm{D}}{ }^{+}=\mathrm{V}_{\mathrm{RF}^{+}}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{CP}}{ }^{+}=\mathrm{V}_{\mathrm{VCO}}{ }^{+}=5 \mathrm{~V}$ unless otherwise specified (Note 2). All voltages are with respect to GND.

| SYMBOL | PARAMETER | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Charge Pump |  |  |  |  |  |  |  |
| $\mathrm{I}_{\text {CP }}$ | Output Current Range | 12 Settings (See Table 5) |  | 0.25 |  | 11.2 | mA |
|  | Output Current Source/Sink Accuracy | All Settings $\mathrm{V}_{\mathrm{CP}}=\mathrm{V}_{\text {CP }}{ }^{+} / 2$ |  |  |  | $\pm 6$ | \% |
|  | Output Current Source/Sink Matching | $\begin{aligned} & \mathrm{I}_{\mathrm{CP}}=250 \mu \mathrm{~A} \text { to } 1.4 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CP}}=\mathrm{V}_{C P^{+}} / 2 \\ & \mathrm{I}_{\mathrm{CP}}=2.0 \mathrm{~mA} \text { to } 11.2 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CP}}=\mathrm{V}_{\mathrm{CP}}+2 \end{aligned}$ |  |  |  | $\begin{gathered} \pm 3.5 \\ \pm 2 \end{gathered}$ | \% |
|  | Output Current vs Output Voltage Sensitivity | (Note 5) | $\bullet$ |  | 0.1 | 1.0 | \%/V |
|  | Output Current vs Temperature | $\mathrm{V}_{\mathrm{CP}}=\mathrm{V}_{\text {CP }}{ }^{+} / 2$ | $\bullet$ |  | 170 |  | $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |
|  | Output Hi-Z Leakage Current | $\begin{aligned} & I_{C P}=700 \mu \mathrm{~A}, \mathrm{CPCLO}=\mathrm{CPCHI}=0(\text { Note } 5) \\ & I_{\mathrm{CP}}=11.2 \mathrm{~mA}, \mathrm{CPCLO}=\mathrm{CPCHI}=0(\text { Note } 5) \end{aligned}$ |  |  | $\begin{gathered} 0.5 \\ 5 \end{gathered}$ |  | nA |
| $\mathrm{V}_{\text {CLMP(L0) }}$ | Low Clamp Voltage | CPCLO $=1$ |  |  | 0.84 |  | V |
| $\mathrm{V}_{\text {CLMP(HI) }}$ | High Clamp Voltage | $\mathrm{CPCHI}=1$, Referred to $\mathrm{V}_{\text {CP }}{ }^{+}$ |  |  | -0.96 |  | V |
| $\mathrm{V}_{\text {MID }}$ | Mid-Supply Output Bias Ratio | Referred to ( $\mathrm{V}_{\text {CP }}{ }^{+}$- GND) |  |  | 0.48 |  | V/N |

## Reference (R) Divider

| R | Divide Range | All Integers Included | $\bullet$ | 1 |  | 1023 | counts |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| VCO (N) Divider |  |  |  |  |  |  |  |
| N | Divide Range | All Integers Included | $\bullet$ | 32 |  | 65535 | counts |
| Digital Pin Specifications |  |  |  |  |  |  |  |
| $\mathrm{V}_{\text {IH }}$ | High Level Input Voltage | $\overline{\text { MUTE, }} \overline{\mathrm{CS}}$, SDI, SCLK | $\bullet$ | 1.55 |  |  | V |
| $\mathrm{V}_{\text {IL }}$ | Low Level Input Voltage | $\overline{\text { MUTE, }} \overline{\text { CS }}$, SDI, SCLK | $\bullet$ |  |  | 0.8 | V |
| $\mathrm{V}_{\text {IHYS }}$ | Input Voltage Hysteresis | $\overline{\text { MUTE, }} \overline{\text { CS }}$, SDI, SCLK |  |  | 250 |  | mV |
|  | Input Current | $\overline{\text { MUTE, }} \overline{\mathrm{CS}}$, SDI, SCLK | $\bullet$ |  |  | $\pm 1$ | $\mu \mathrm{A}$ |
| $\mathrm{IOH}^{\text {O }}$ | High Level Output Current | SDO and STAT, $\mathrm{V}_{\mathrm{OH}}=\mathrm{V}_{\mathrm{D}}{ }^{+}-400 \mathrm{mV}$ | $\bullet$ |  | -2.3 | -1.4 | mA |
| $\underline{10 L}$ | Low Level Output Current | SDO and STAT, $\mathrm{V}_{0 \mathrm{~L}}=400 \mathrm{mV}$ | $\bullet$ | 1.8 | 2.6 |  | mA |
|  | SDO Hi-Z Current |  | $\bullet$ |  |  | $\pm 1$ | $\mu \mathrm{A}$ |

## Digital Timing Specifications (See Figures 7 and 8)

| $t_{\text {CKH }}$ | SCLK High Time |  | $\bullet$ | 25 | ns |
| :--- | :--- | :--- | :--- | :--- | :---: |
| $t_{\text {CKL }}$ | SCLK Low Time |  | $\bullet$ | 25 | ns |
| $t_{\text {CSS }}$ | $\overline{\text { CS Setup Time }}$ |  | $\bullet$ | 10 | ns |
| $t_{\text {CSH }}$ | $\overline{\text { CS }}$ High Time |  | $\bullet$ | 10 | ns |
| $t_{\text {CS }}$ | SDI to SCLK Setup Time | $\bullet$ | 6 | ns |  |
| $t_{\text {CH }}$ | SDI to SCLK Hold Time |  | $\bullet$ | 6 | ns |
| $t_{\text {DO }}$ | SCLK to SDO Time | To $V_{\text {IH }} / V_{\text {IL }} / H i-Z$ with 30pF Load | $\bullet$ |  | ns |

## Power Supply Voltages

|  | V $_{\text {REF }}{ }^{+}$Supply Range |  | $\bullet$ | 3.15 | 3.3 | 3.45 | V |
| :--- | :--- | :--- | :--- | :--- | :--- | :---: | :---: |
|  | $\mathrm{~V}_{\text {REFO }}{ }^{+}$Supply Range |  | $\bullet$ | 3.15 | 3.3 | 3.45 | V |
|  | $\mathrm{~V}_{\mathrm{D}}{ }^{+}$Supply Range |  | $\bullet$ | 3.15 | 3.3 | 3.45 | V |
|  | $\mathrm{~V}_{\text {RF }}{ }^{+}$Supply Range |  | $\bullet$ | 3.15 | 3.3 | 3.45 | V |
|  | $\mathrm{~V}_{\mathrm{VCO}^{+} \text {Supply Range }}$ |  | $\bullet$ | 4.75 | 5.0 | 5.25 | V |
|  | $\mathrm{~V}_{\text {CP }}{ }^{+}$Supply Range | $\bullet$ | 4.0 |  | 5.25 | V |  |

## ELECTRGALCHARACTERASTCS The • denotes the specifications which apply over the full operating

 junction temperature range, otherwise specifications are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C} . \mathrm{V}_{\mathrm{REF}}{ }^{+}=\mathrm{V}_{\mathrm{REFO}}{ }^{+}=\mathrm{V}_{\mathrm{D}}{ }^{+}=\mathrm{V}_{\mathrm{RF}}{ }^{+}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{CP}^{+}}=\mathrm{V}_{\mathrm{VCO}}{ }^{+}=5 \mathrm{~V}$ unless otherwise specified (Note 2). All voltages are with respect to GND.| SYMBOL | PARAMETER | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Power Supply Currents |  |  |  |  |  |  |  |
| $\underline{\text { ID }}$ | $\mathrm{V}_{\mathrm{D}}+$ Supply Current | Digital Inputs at Supply Levels | $\bullet$ |  |  | 500 | $\mu \mathrm{A}$ |
| ${ }^{\text {CC(5V) }}$ | Sum $\mathrm{V}_{\mathrm{CP}}{ }^{+}$, $\mathrm{VVCO}^{+}$Supply Currents | $\begin{aligned} & \mathrm{I}_{\mathrm{CP}}=11.2 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{CP}}=1.0 \mathrm{~mA} \\ & \mathrm{PDALL}=1 \end{aligned}$ | $\stackrel{\bullet}{\bullet}$ |  | $\begin{gathered} 50 \\ 28 \\ 405 \end{gathered}$ | $\begin{gathered} \hline 63 \\ 39 \\ 660 \end{gathered}$ | $\begin{aligned} & \mathrm{mA} \\ & \mathrm{~mA} \end{aligned}$ $\mu \mathrm{A}$ |
| $\underline{I C C(R E F O)}$ | $\mathrm{V}_{\text {REFO }}{ }^{+}$Supply Currents | REFO Enabled, $\mathrm{R}_{\mathrm{z}}=\infty$ | $\bullet$ |  | 7.8 | 9.0 | mA |
| $I_{\text {CC ( }}^{\text {(3.3V) }}$ | Sum $\mathrm{VREF}^{+}$, $\mathrm{VRF}^{+}$Supply Currents | RF Muted, OD[2:0] = 1 <br> RF Enabled, RFO[1:0] $=0,0 \mathrm{D}[2: 0]=1$ <br> RF Enabled, RFO[1:0] $=3,0 \mathrm{D}[2: 0]=1$ <br> RF Enabled, RFO[1:0] $=3,0 \mathrm{D}[2: 0]=2$ <br> RF Enabled, RFO[1:0] $=3,0 \mathrm{D}[2: 0]=3$ <br> RF Enabled, RFO[1:0] $=3,0 \mathrm{D}[2: 0]=4$ to 6 PDALL $=1$ | $\stackrel{\bullet}{\bullet}$ |  | $\begin{aligned} & 65 \\ & 76 \\ & 85 \\ & 103 \\ & 108 \\ & 113 \\ & 195 \end{aligned}$ | $\begin{gathered} 76 \\ 86 \\ 97 \\ 117 \\ 123 \\ 128 \\ 340 \end{gathered}$ | $\begin{aligned} & \mathrm{mA} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \end{aligned}$ $\mathrm{mA}$ $\mu \mathrm{A}$ |

## Phase Noise and Spurious

| $\mathrm{L}_{\mathrm{M}}$ | Phase Noise (LTC6946-1, $\mathrm{f}_{\mathrm{VCO}}=3.0 \mathrm{GHz}$, $\mathrm{f}_{\mathrm{RF}}$ $=3.0 \mathrm{GHz}, \mathrm{OD}[2: 0]=1$ (Note 6)) | 10 kHz Offset 1MHz Offset 40MHz Offset | $\begin{gathered} -80 \\ -130 \\ -157 \end{gathered}$ | $\mathrm{dBc} / \mathrm{Hz}$ $\mathrm{dBc} / \mathrm{Hz}$ $\mathrm{dBc} / \mathrm{Hz}$ |
| :---: | :---: | :---: | :---: | :---: |
|  | Phase Noise (LTC6946-2, $\mathrm{f}_{\mathrm{VCO}}=4.0 \mathrm{GHz}$, $\mathrm{f}_{\mathrm{RF}}$ $=4.0 \mathrm{GHz}, \mathrm{OD}[2: 0]=1($ Note 6$))$ | 10 kHz Offset 1MHz Offset 40MHz Offset | $\begin{gathered} \hline-77 \\ -127 \\ -156 \end{gathered}$ | $\mathrm{dBc} / \mathrm{Hz}$ $\mathrm{dBc} / \mathrm{Hz}$ $\mathrm{dBc} / \mathrm{Hz}$ |
|  | Phase Noise (LTC6946-3, fvco $=5.0 \mathrm{GHz}$, f fF $=5.0 \mathrm{GHz}, \mathrm{OD}[2: 0]=1$ (Note 6)) | 10kHz Offset 1 MHz Offset 40MHz Offset | $\begin{gathered} \hline-75 \\ -126 \\ -155 \end{gathered}$ | $\mathrm{dBC} / \mathrm{Hz}$ $\mathrm{dBc} / \mathrm{Hz}$ $\mathrm{dBc} / \mathrm{Hz}$ |
|  | VCO Phase Noise (LTC6946-4, f $\mathrm{f}_{\text {VCo }}=$ $6.0 \mathrm{GHz}, \mathrm{f}_{\mathrm{RF}}=6.0 \mathrm{GHz}, \mathrm{OD}[2: 0]=1$ (Note 6)) | 10 kHz Offset 1 MHz Offset 40MHz Offset | $\begin{gathered} -73 \\ -132 \\ -154 \end{gathered}$ | $\mathrm{dBc} / \mathrm{Hz}$ $\mathrm{dBc} / \mathrm{Hz}$ $\mathrm{dBc} / \mathrm{Hz}$ |
|  | Phase Noise (LTC6946-3, fvco $=5.0 \mathrm{GHz}$, $\mathrm{f}_{\mathrm{RF}}$ $=2.50 \mathrm{GHz}, \mathrm{OD}[2: 0]=2$ (Note 6)) | 10kHz Offset 1 MHz Offset 40MHz Offset | $\begin{gathered} \hline-81 \\ -132 \\ -155 \end{gathered}$ | $\mathrm{dBc} / \mathrm{Hz}$ $\mathrm{dBc} / \mathrm{Hz}$ $\mathrm{dBc} / \mathrm{Hz}$ |
|  | Phase Noise (LTC6946-3, fyco $=5.0 \mathrm{GHz}$, $\mathrm{f}_{\mathrm{RF}}$ $=1.667 \mathrm{GHz}, \mathrm{OD}[2: 0]=3$ (Note 6)) | 10 kHz Offset 1 MHz Offset 40MHz Offset | $\begin{gathered} \hline-84 \\ -135 \\ -156 \end{gathered}$ | $\mathrm{dBc} / \mathrm{Hz}$ $\mathrm{dBc} / \mathrm{Hz}$ $\mathrm{dBc} / \mathrm{Hz}$ |
|  | Phase Noise (LTC6946-3, $\mathrm{f}_{\mathrm{VCO}}=5.0 \mathrm{GHz}$, $\mathrm{f}_{\mathrm{RF}}$ $=1.25 \mathrm{GHz}, \mathrm{OD}[2: 0]=4$ (Note 6 )) | 10 kHz Offset 1 MHz Offset 40MHz Offset | $\begin{gathered} -87 \\ -138 \\ -156 \end{gathered}$ | $\mathrm{dBc} / \mathrm{Hz}$ $\mathrm{dBc} / \mathrm{Hz}$ $\mathrm{dBc} / \mathrm{Hz}$ |
|  | Phase Noise (LTC6946-3, $\mathrm{f}_{\mathrm{Vco}}=5.0 \mathrm{GHz}$, $\mathrm{f}_{\mathrm{RF}}$ $=1.00 \mathrm{GHz}, \mathrm{OD}[2: 0]=5($ Note 6$))$ | 10 kHz Offset 1 MHz Offset 40MHz Offset | $\begin{gathered} \hline-89 \\ -140 \\ -157 \end{gathered}$ | $\mathrm{dBc} / \mathrm{Hz}$ $\mathrm{dBc} / \mathrm{Hz}$ $\mathrm{dBc} / \mathrm{Hz}$ |
|  | Phase Noise (LTC6946-3, $\mathrm{f}_{\mathrm{Vco}}=5.0 \mathrm{GHz}$, $\mathrm{f}_{\mathrm{RF}}$ $=0.833 \mathrm{GHz}, \mathrm{OD}[2: 0]=6($ Note 6$))$ | 10 kHz Offset 1 MHz Offset 40MHz Offset | $\begin{gathered} \hline-90 \\ -141 \\ -158 \end{gathered}$ | $\mathrm{dBc} / \mathrm{Hz}$ $\mathrm{dBc} / \mathrm{Hz}$ $\mathrm{dBc} / \mathrm{Hz}$ |
| L ${ }_{\text {M(NORM) }}$ | Normalized In-Band Phase Noise Floor | $\mathrm{I}_{\mathrm{CP}}=11.2 \mathrm{~mA}$ (Notes 7, 8, 9) | -226 | $\mathrm{dBc} / \mathrm{Hz}$ |
| $\underline{L_{\text {M(NORM }} \text {-1/f) }}$ | Normalized In-Band 1/f Phase Noise | $\mathrm{I}_{\mathrm{CP}}=11.2 \mathrm{~mA}$ (Notes 7, 10) | -274 | dBc/Hz |
| $\underline{\mathrm{L}_{\text {M ( }} \text { (B) }}$ | In-Band Phase Noise Floor | (Notes 7, 8, 9, 11) | -99 | $\mathrm{dBc} / \mathrm{Hz}$ |
|  | Integrated Phase Noise from 100 Hz to 40 MHz | (Notes 8, 12) | 0.17 | ${ }^{\circ} \mathrm{RMS}$ |
|  | Spurious | $\mathrm{f}_{\text {OFFSET }}=\mathrm{f}_{\text {PFD }}$, PLL Locked (Notes 8, 12, 13) | -103 | dBc |

## ELECTRICAL CHARACTERISTICS

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.
Note 2: The LTC6946I is guaranteed to meet specified performance limits over the full operating junction temperature range of $-40^{\circ} \mathrm{C}$ to $105^{\circ} \mathrm{C}$. Under maximum operating conditions, air flow or heat sinking may be required to maintain a junction temperature of $105^{\circ} \mathrm{C}$ or lower. It is strongly recommended that the exposed pad (Pin 29) be soldered directly to the ground plane with an array of thermal vias as described in the Applications Information section.
Note 3: Valid for $1.60 \mathrm{~V} \leq$ TUNE $\leq 2.85 \mathrm{~V}$ with part calibrated after a power cycle or software power-on-reset (POR).
Note 4: Based on characterization.
Note 5: For $0.9 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CP}} \leq\left(\mathrm{V}_{C P^{+}}-0.9 \mathrm{~V}\right)$.
Note 6: Measured outside the loop bandwidth, using a narrowband loop, RFO[1:0] = 3 .

Note 7: Measured inside the loop bandwidth with the loop locked.
Note 8: Reference frequency supplied by Wenzel 501-04608A, $f_{\text {REF }}=10 \mathrm{MHz}, P_{\text {REF }}=13 \mathrm{dBm}$.
Note 9: Output phase noise floor is calculated from normalized phase noise floor by $L_{M(O U T)}=-226+10 \log _{10}\left(f_{\text {PFD }}\right)+20 \log _{10}\left(f_{\text {RF }} / f_{\text {PFD }}\right)$.
Note 10: Output $1 / f$ phase noise is calculated from normalized $1 / f$ phase noise by $\mathrm{L}_{\text {M(OUT }-1 / f)}=-274+20 \log _{10}\left(f_{\text {RF }}\right)-10 \log _{10}\left(f_{\text {OFFSET }}\right)$.
Note 11: $I_{C P}=11.2 \mathrm{~mA}, \mathrm{f}_{\text {PFD }}=250 \mathrm{kHz}$, FILT[1:0] = 3, Loop BW $=25 \mathrm{kHz}$; $\mathrm{f}_{\mathrm{RF}}=900 \mathrm{MHz}, \mathrm{f}_{\mathrm{vc}}=2.7 \mathrm{GHz}(\mathrm{LTC6946-1}), \mathrm{f}_{\mathrm{vc}}=3.6 \mathrm{GHz}($ LTC6946-2 $)$, $\mathrm{f}_{\mathrm{V} C 0}=4.5 \mathrm{GHz}$ (LTC6946-3, LTC6946-4).
Note 12: $I_{C P}=11.2 \mathrm{~mA}, \mathrm{I}_{\text {PFD }}=1 \mathrm{MHz}, \operatorname{FILT}[1: 0]=3$, Loop BW $=40 \mathrm{kHz}$; $f_{R F}=900 \mathrm{MHz}, f_{V C O}=2.7 \mathrm{GHz}\left(\right.$ LTC6946-1), $f_{V C 0}=3.6 \mathrm{GHz}($ LTC6946-2), $f_{V C O}=4.5 \mathrm{GHz}$ (LTC6946-3, LTC6946-4).
Note 13: Measured using DC1705.

## TYPICAL PERFORMAOCE CHARACTERISTICS

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\text {REF }^{+}}=\mathrm{V}_{\text {REFO }^{+}}=\mathrm{V}_{\mathrm{D}}{ }^{+}=\mathrm{V}_{\mathrm{RF}^{+}}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{CP}^{+}}=\mathrm{V}_{\mathrm{VCO}}{ }^{+}=5 \mathrm{~V}, \mathrm{RFO}[1: 0]=3$, unless otherwise noted.


6946 G01


Charge Pump Source Current
Error vs Voltage, Temperature


REFO Output Power vs Frequency


Charge Pump Sink Current Error vs Voltage, Temperature


RF Output Power vs Frequency (Single Ended on RF-)


REFO Phase Noise


Charge Pump Source Current Error vs Voltage, Output Current


RF Output HD2 vs Output Divide (Single Ended on RF-)


## TYPICAL PERFORMANCE CHARACTERISTICS

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{REF}^{+}}=\mathrm{V}_{\mathrm{REFO}^{+}}=\mathrm{V}_{\mathrm{D}^{+}}=\mathrm{V}_{\mathrm{RF}^{+}}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{CP}^{+}}=\mathrm{V}_{\mathrm{VCO}}{ }^{+}=5 \mathrm{~V}, \mathrm{RFO}[1: 0]=3$, unless otherwise noted.


## TYPICAL PERFORMAOCE CHARACTERISTICS

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\text {REF }^{+}}=\mathrm{V}_{\mathrm{REFO}^{+}}=\mathrm{V}_{\mathrm{D}}{ }^{+}=\mathrm{V}_{\mathrm{RF}^{+}}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{CP}^{+}}=\mathrm{V}_{\mathrm{VCO}}{ }^{+}=5 \mathrm{~V}, \mathrm{RFO}[1: 0]=3$, unless otherwise noted.


LTC6946-2 VCO Phase Noise vs $\mathrm{f}_{\mathrm{VCO}}$, Output Divide ( $\mathrm{f}_{\mathrm{OFFSET}}=10 \mathrm{kHz}$ )


LTC6946-1 VCO Phase Noise vs $\mathrm{f}_{\text {Vco }}$, Output Divide ( $\mathrm{f}_{\mathrm{OFFSET}}=1 \mathrm{MHz}$ )


LTC6946-4 VCO Phase Noise


LTC6946-3 VCO Phase Noise vs
$\mathrm{f}_{\text {VCO }}$, Output Divide ( $\mathrm{f}_{\text {OFFSET }}=10 \mathrm{kHz}$ )


LTC6946-2 VCO Phase Noise vs $\mathrm{f}_{\mathrm{VCO}}$, Output Divide (fofFSET $=1 \mathrm{MHz}$ )


LTC6946-1 VCO Phase Noise vs fuco, Output Divide ( $\mathrm{f}_{\text {OFFSET }}=10 \mathrm{kHz}$ )


6946 G21
LTC6946-4 VCO Phase Noise vs
$\mathrm{f}_{\mathrm{vco}}$, Output Divide (foffset $=10 \mathrm{kHz}$ )


LTC6946-3 VCO Phase Noise vs fyco, Output Divide (foffset $=1 \mathrm{MHz}$ )


## TYPICAL PERFORMANCE CHARACTERISTICS

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{REF}^{+}}=\mathrm{V}_{\mathrm{REFO}^{+}}=\mathrm{V}_{\mathrm{D}}{ }^{+}=\mathrm{V}_{\mathrm{RF}^{+}}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{CP}^{+}}=\mathrm{V}_{\mathrm{VCO}}{ }^{+}=5 \mathrm{~V}, \mathrm{RFO}[1: 0]=3$, unless otherwise noted.


Closed-Loop Phase Noise, Loop
Bandwidth = 40kHz, LTC6946-1


Closed-Loop Phase Noise, Loop
Bandwidth = 25kHz, LTC6946-3


LTC6946-3 Spurious Response
$f_{\text {RF }}=900 \mathrm{MHz}, f_{\text {REF }}=10 \mathrm{MHz}$,
$\mathrm{f}_{\mathrm{PFD}}=1 \mathrm{MHz}$, Loop BW $=40 \mathrm{kHz}$


6946 G32
LTC6946-3 Spurious Response
$\mathrm{f}_{\mathrm{RF}}=5700 \mathrm{MHz}, \mathrm{f}_{\mathrm{REF}}=100 \mathrm{MHz}$,
$f_{\text {PFD }}=1 \mathrm{MHz}$, Loop BW $=33 \mathrm{kHz}$


## PIN fUNCTIONS

V $_{\text {REFO }}{ }^{+}$(Pin 1): 3.15 V to 3.45 V Positive Supply Pin for REFO Circuitry. This pin should be bypassed directly to the ground plane using a $0.1 \mu \mathrm{~F}$ ceramic capacitor as close to the pin as possible.
REFO (Pin 2): Reference Frequency Output. This produces a low noise square wave, buffered from the REF ${ }^{ \pm}$differential inputs. The output is self-biased and must be AC-coupled with a 22 nF capacitor.

STAT (Pin 3): Status Output. This signal is a configurable logical OR combination of the UNLOCK, LOCK, ALCHI, ALCLO, THI and TLO status bits, programmable via the STATUS register. See the Operation section for more details.
$\overline{\text { CS }}$ (Pin 4): Serial Port Chip Select. This CMOS input initiates a serial port communication burst when driven low, ending the burst when driven back high. See the Operation section for more details.

SCLK (Pin 5): Serial Port Clock. This CMOS input clocks serial port input data on its rising edge. See the Operation section for more details.

SDI (Pin 6): Serial Port Data Input. The serial port uses this CMOS input for data. See the Operation section for more details.

SDO (Pin 7): Serial Port Data Output. This CMOS threestate output presents data from the serial port during a read communication burst. Optionally attach a resistor of >200k to GND to prevent a floating output. See the Operation section for more details.
$\mathrm{V}_{\mathrm{D}}{ }^{+}$(Pin 8 ): 3.15 V to 3.45 V Positive Supply Pin for Serial Port Circuitry. This pin should be bypassed directly to the ground plane using a $0.1 \mu \mathrm{~F}$ ceramic capacitor as close to the pin as possible.
$\overline{\text { MUTE (Pin 9): RF Mute. The CMOS active-low input mutes }}$ the RF $\pm$ differential outputs while maintaining internal bias levels for quick response to de-assertion.

GND (Pins 10, 17, 21): Negative Power Supply (Ground). These pins should be tied directly to the ground plane with multiple vias for each pin.

RF $^{-}$, RF $^{+}$(Pins 11, 12): RF Output Signals. The VCO output divider is buffered and presented differentially on these pins. The outputs are open collector, with $136 \Omega$ (typical) pull-up resistors tied to $\mathrm{VRF}^{+}$to aid impedance matching. If used single ended, the unused output should be terminated to $50 \Omega$. See the Applications Information section for more details on impedance matching.
$\mathbf{V}_{\mathrm{RF}}{ }^{+}$(Pin 13): 3.15 V to 3.45 V Positive Supply Pin for RF Circuitry. This pin should be bypassed directly to the ground plane using a $0.01 \mu \mathrm{~F}$ ceramic capacitor as close to the pin as possible.
BB (Pin 14): RF Reference Bypass. This output must be bypassed with a $1.0 \mu \mathrm{~F}$ ceramic capacitor to GND. Do not couple this pin to any other signal.

TUNE (Pin 15): VCO Tuning Input. This frequency control pin is normally connected to the external loop filter. See the Applications Information section for more details.
TB (Pin 16): VCO Bypass. This output must be bypassed with a $2.2 \mu \mathrm{~F}$ ceramic capacitor to GND, and is normally connected to $\mathrm{CM}_{\mathrm{A}}, \mathrm{CM}_{\mathrm{B}}$ and $\mathrm{CM}_{\mathrm{C}}$ with a short trace. Do not couple this pin to any other signal.
$\mathrm{CM}_{\mathrm{C}}, \mathrm{CM}_{\mathrm{B}}, \mathrm{CM}_{\mathrm{A}}$ (Pins 18, 19, 20): VCO Bias Inputs. These inputs are normally connected to TB with a short trace and bypassed with a $2.2 \mu \mathrm{~F}$ ceramic capacitor to GND. Do not couple these pins to any other signal. For best phase noise performance, do not place a trace between these pads underneath the package.

V ${ }_{\text {VCo }}{ }^{+}$(Pin 22): 4.75 V to 5.25 V Positive Supply Pin for VCO Circuitry. This pin should be bypassed directly to the ground plane using both $0.01 \mu \mathrm{~F}$ and $1 \mu \mathrm{~F}$ ceramic capacitors as close to the pin as possible.

## PIn fUnCTIONS

GND (23): Negative Power Supply (Ground). This pin is attached directly to the die attach paddle (DAP) and should be tied directly to the ground plane.

VCP ${ }^{+}$(Pin 24): 4.0V to 5.25V Positive Supply Pin for Charge Pump Circuitry. This pin should be bypassed directly to the ground plane using a $0.1 \mu \mathrm{~F}$ ceramic capacitor as close to the pin as possible.

CP (Pin 25): Charge Pump Output. This bi-directional current output is normally connected to the external loop filter. See the Applications Information section for more details.
V $_{\text {REF }}{ }^{+}$(Pin 26): 3.15 V to 3.45 V Positive Supply Pin for Reference Input Circuitry. This pin should be bypassed directly to the ground plane using a $0.1 \mu \mathrm{~F}$ ceramic capacitor as close to the pin as possible.

REF ${ }^{+}$, REF $^{-}$(Pins 27, 28): Reference Input Signals. This differential input is buffered with a low noise amplifier, which feeds the reference divider and reference buffer. They are self-biased and must be AC-coupled with $1 \mu \mathrm{~F}$ capacitors. If used single ended, bypass REF- to GND with a $1 \mu \mathrm{~F}$ capacitor. If the single-ended signal is greater than 2.7Vp-p, bypass REF- to GND with a 47 pF capacitor.
GND (Exposed Pad Pin 29): Negative Power Supply (Ground). The package exposed pad must be soldered directly to the PCB land. The PCB land pattern should have multiple thermal vias to the ground plane for both low ground inductance and also low thermal resistance.

## BLOCK DIAGRAM



## operation

The LTC6946 is a high performance PLL complete with a low noise VCO available in three different frequency range options. The output frequency range may be further extended by utilizing the output divider (see Available Options table, for more details). The device is able to achieve superior integrated phase noise by the combination of its extremely low in-band phase noise performance and excellent VCO noise characteristics.

## REFERENCE INPUT BUFFER

The PLL's reference frequency is applied differentially on pins REF ${ }^{+}$and REF-. These high impedance inputs are self-biased and must be AC-coupled with $1 \mu \mathrm{~F}$ capacitors (see Figure 1 for a simplified schematic). Alternatively, the inputs may be used single ended by applying the reference frequency at REF ${ }^{+}$and bypassing REF $^{-}$to GND with a $1 \mu \mathrm{~F}$ capacitor. If the single-ended signal is greater than $2.7 \mathrm{~V}_{\mathrm{p}-\mathrm{p}}$, then use a 47 pF capacitor for the GND bypass.


Figure 1. Simplified REF Interface Schematic
A high quality signal must be applied to the REF ${ }^{ \pm}$inputs as they provide the frequency reference to the entire PLL. To achieve the part's in-band phase noise performance, apply a CW signal of at least 6 dBm into $50 \Omega$, or a square wave of at least 0.5 V P-p with slew rate of at least $40 \mathrm{~V} / \mu \mathrm{s}$.
Additional options are available through serial port register h08 to further refine the application. Bits FILT[1:0] control the reference input buffer's lowpass filter, and should be set based upon $f_{\text {REF }}$ to limit the reference's wideband noise. The FILT[1:0] bits must be set correctly to reach the $L_{M(N O R M)}$ normalized in-band phase noise floor. See Table 1 for recommended settings.

The BST bit should be set based upon the input signal level to prevent the reference input buffer from saturating. See Table 2 for recommended settings and the Applications Information section for programming examples.

Table 1. FILT[1:0] Programming

| FILT[1:0] | $\mathrm{f}_{\text {REF }}$ |
| :---: | :---: |
| 3 | $<20 \mathrm{MHz}$ |
| 2 | NA |
| 1 | 20 MHz to 50 MHz |
| 0 | $>50 \mathrm{MHz}$ |

Table 2. BST Programming

| BST | V $_{\text {REF }}$ |
| :---: | :---: |
| 1 | $<2.0 \mathrm{~V}_{\text {P-P }}$ |
| 0 | $\geq 2.0 \mathrm{~V}_{\text {P-P }}$ |

## REFERENCE OUTPUT BUFFER

The reference output buffer produces a low noise square wave with a noise floor of $-155 \mathrm{dBc} / \mathrm{Hz}$ (typical) at 10 MHz . Its output is low impedance, and produces 0 dBm typical output power into a $50 \Omega$ load at 10 MHz . Larger output swings will result if driving larger impedances. The output is self-biased, and must be AC-coupled with a $22 n \mathrm{n}$ capacitor (see Figure 2 for a simplified schematic). The buffer may be powered down by using bit PDREFO found in the serial port Power register h02.


Figure 2. Simplified REFO Interface Schematic

## OPERATION

## REFERENCE (R) DIVIDER

A 10-bit divider, R_DIV, is used to reduce the frequency seen at the PFD. Its divide ratio R may be set to any integer from 1 to 1023, inclusive. Use the RD[9:0] bits found in registers h03 and h04 to directly program the R divide ratio. See the Applications Information section for the relationship between $R$ and the $f_{\text {REF }}, f_{P F D}, f_{V C O}$ and $f_{R F}$ frequencies.

## PHASE/FREQUENCY DETECTOR (PFD)

The phase/frequency detector (PFD), in conjunction with the charge pump, produces source and sink current pulses proportional to the phase difference between the outputs of the R and N dividers. This action provides the necessary feedback to phase-lock the loop, forcing a phase alignment at the PFD's inputs. The PFD may be disabled with the CPRST bit which prevents UP and DOWN pulses from being produced. See Figure 3 for a simplified schematic of the PFD.


Figure 3. Simplified PFD Schematic

## LOCK INDICATOR

The lock indicator uses internal signals from the PFD to measure phase coincidence between the R and N divider output signals. It is enabled by setting the LKEN bit in the serial port register h07, and produces both LOCK and UNLOCK status flags, available through both the STAT output and serial port register h00.

The user sets the phase difference lock window time, tlww, for a valid LOCK condition with the LKWIN[1:0] bits. See Table 3 for recommended settings for different FPFD frequencies and the Applications Information section for examples.

Table 3. LKWIN[1:0] Programming

| LKWIN[1:0] | $\mathbf{t}_{\text {LWW }}$ | $\mathbf{f}_{\text {PFD }}$ |
| :---: | :---: | :---: |
| 0 | 3 ns | $>5 \mathrm{MHz}$ |
| 1 | 10 ns | $\leq 5 \mathrm{MHz}$ |
| 2 | 30 ns | $\leq 1.7 \mathrm{MHz}$ |
| 3 | 90 ns | $\leq 550 \mathrm{kHz}$ |

The PFD phase difference must be less than $t_{\text {Lww }}$ for the LOKCNT number of successive counts before the lock indicator asserts the LOCK flag. The LKCNT[1:0] bits found in register h09 are used to set LOKCNT depending upon the application. See Table 4 for LKCNT[1:0] programming and the Applications Information section for examples.

Table 4. LKCNT[1:0] Programming

| LKCNT[1:0] | COUNTS |
| :---: | :---: |
| 0 | 32 |
| 1 | 128 |
| 2 | 512 |
| 3 | 2048 |

When the PFD phase difference is greater than $t_{\text {Lww }}$, the lock indicator immediately asserts the UNLOCK status flag and clears the LOCK flag, indicating an out-of-lock condition. The UNLOCK flag is immediately de-asserted when the phase difference is less than tLww. See Figure 4 for more details.


Figure 4. UNLOCK and LOCK Timing

## OPERATION

## CHARGE PUMP

The charge pump, controlled by the PFD, forces sink (DOWN) or source (UP) current pulses onto the CP pin, which should be connected to an appropriate loop filter. See Figure 5 for a simplified schematic of the charge pump.


Figure 5. Simplified Charge Pump Schematic
The output current magnitude $\mathrm{I}_{\mathrm{CP}}$ may be set from $250 \mu \mathrm{~A}$ to 11.2 mA using the CP[3:0] bits found in serial port register h09. A larger $I_{\text {CP }}$ can result in lower in-band noise due to the lower impedance of the loop filter components. See Table 5 for programming specifics and the Applications Information section for loop filter examples.

Table 5. CP[3:0] Programming

| CP[3:0] | $\mathbf{I}_{\mathbf{C P}}$ |
| :---: | :---: |
| 0 | $250 \mu \mathrm{~A}$ |
| 1 | $350 \mu \mathrm{~A}$ |
| 2 | $500 \mu \mathrm{~A}$ |
| 3 | $700 \mu \mathrm{~A}$ |
| 4 | 1.0 mA |
| 5 | 1.4 mA |
| 6 | 2.0 mA |
| 7 | 2.8 mA |
| 8 | 4.0 mA |
| 9 | 5.6 mA |
| 10 | 8.0 mA |
| 11 | 11.2 mA |
| 12 to 15 | Invalid |

The CPINV bit found in register hOA should be set for applications requiring signal inversion from the PFD, such as for complex external loops using an inverting op amp. A passive loop filter as shown in Figure 14 requires CPINV = 0 .

## CHARGE PUMP FUNCTIONS

The charge pump contains additional features to aid in system start-up and monitoring. See Table 6 for a summary.

Table 6. Charge Pump Function Bit Descriptions

| BIT | DESCRIPTION |
| :---: | :---: |
| CPCHI | Enable High Voltage Output Clamp |
| CPCLO | Enable Low Voltage Output Clamp |
| CPDN | Force Sink Current |
| CPINV | Invert PFD Phase |
| CPMID | Enable Mid-Voltage Bias |
| CPRST | Reset PFD |
| CPUP | Force Source Current |
| CPWIDE | Extend Current Pulse Width |
| THI | High Voltage Clamp Flag |
| TLO | Low Voltage Clamp Flag |

The CPCHI and CPCLO bits found in register hOA enable the high and low voltage clamps, respectively. When CPCHI is enabled and the CP pin voltage exceeds approximately $\mathrm{V}_{\mathrm{CP}}{ }^{+}-0.9 \mathrm{~V}$, the THI status flag is set, and the charge pump sourcing current is disabled. Alternately, when CPCLO is enabled and the CP pin voltage is less than approximately 0.9 V , the TLO status flag is set, and the charge pump sinking current is disabled. See Figure 5 for a simplified schematic.
The CPMID bit also found in register hOA enables a resistive $\mathrm{V}_{\mathrm{CP}}{ }^{+} / 2$ output bias which may be used to pre-bias troublesome loop filters into a valid voltage range. When using CPMID, it is recommended to also assert the CPRST bit, forcing a PFD reset. Both CPMID and CPRST must be set to "0" for normal operation.

## OPERATION

The CPUP and CPDN bits force a constant $I_{C P}$ source or sink current, respectively, on the CP pin. The CPRST bit may also be used in conjunction with the CPUP and CPDN bits, allowing a pre-charge of the loop to a known state, if required. CPUP, CPDN, and CPRST must be set to "0" to allow the loop to lock.

The CPWIDE bit extends the charge pump output current pulse width by increasing the PFD reset path's delay value (see Figure 3). CPWIDE is normally set to 0.

## VCO

The integrated VCO is available in one of three frequency ranges. The output frequency range may be further extended by utilizing the output divider (see Available Options table, for more details). The wide frequency range of the VCO, coupled with the output divider capability, allows the LTC6946 to cover an extremely wide range of continuously selectable frequencies.

## VCO Calibration

The VCO must be calibrated each time its frequency is changed by either $f_{\text {REF }}$, the $R$ divider, or $N$ divider, but not the 0 divider (see the Applications Information section for the relationship between $R, N, 0$, and the $f_{\text {REF }}, f_{\text {PFD }}, f_{V C O}$ and $f_{R F}$ frequencies). The output frequency is then stable over the LTC6946's entire temperature range, regardless of the temperature at which it was calibrated, until the part is reset due to a power cycle or software power-on reset (POR).
The output of the $B$ divider is used to clock digital calibration circuitry as shown in the Block Diagram. The B value, programmed with bits $\mathrm{BD}[3: 0]$, is determined according to Equation 1.

$$
\begin{equation*}
\mathrm{B} \geq \frac{\mathrm{f}_{\mathrm{PFD}}}{\mathrm{f}_{\mathrm{CAL}-\mathrm{MAX}}} \tag{1}
\end{equation*}
$$

The maximum calibration frequency ${ }_{\mathrm{CAL}}$-MAX for each part option is shown in Table 7.

Table 7. Maximum Calibration Frequency

| PART | $\mathbf{f}_{\text {CAL-max }}$ (MHz) |
| :---: | :---: |
| LTC6946-1 | 1.0 |
| LTC6946-2 | 1.33 |
| LTC6946-3 | 1.7 |
| LTC6946-4 | 1.8 |

The relationship between bits $B D[3: 0]$ and the $B$ value is shown in Table 8.

Table 8. BD[3:0] Programming

| BD[3:0] | B DIVIDE VALUE |
| :---: | :---: |
| 0 | 8 |
| 1 | 12 |
| 2 | 16 |
| 3 | 24 |
| 4 | 32 |
| 5 | 48 |
| 6 | 64 |
| 7 | 96 |
| 8 | 128 |
| 9 | 192 |
| 10 | 256 |
| 11 | 384 |
| 12 to 15 | Invalid |

The VCO may be calibrated once the RD[9:0], ND[15:0], and $B D[3: 0]$ bits are written. The reference frequency $f_{\text {REF }}$ must also be present and stable at the REF ${ }^{ \pm}$inputs.

A calibration cycle is initiated each time the CAL bit is written to "1" (the bit is self-clearing). The calibration cycle takes between 12 and 14 cycles of the B divider output.

## operation

## VCO Automatic Level Control (ALC)

The VCO uses an internal automatic level control (ALC) algorithm to maintain an optimal amplitude on the VCO resonator, and thus optimal phase noise performance. The user has several ALC configuration and status reporting options as seen in Table 9.

Table 9. ALC Bit Descriptions

| BIT | DESCRIPTION |
| :---: | :--- |
| ALCCAL | Auto Enable ALC During CAL Operation |
| ALCEN | Always Enable ALC (Overrides ALCCAL, ALCMON and <br> ALCULOK) |
| ALCHI | ALC Too High Flag (Resonator Amplitude Too High) |
| ALCLO | ALC Too Low Flag (Resonator Amplitude Too Low) |
| ALCMON | Enable ALC Monitoring for Status Flags Only; Does NOT <br> Enable Amplitude Control |
| ALCULOK | Auto Enable ALC when PLL Unlocked |

Changes in the internal ALC output can cause extremely small jumps in the VCO frequency. These jumps may be acceptable in some applications but not in others. Use the above table to choose when the ALC is active. The ALCHI and ALCLO flags, valid only when the ALC is active or the ALCMON bit is set, may be used to monitor the resonator amplitude.

The ALC must be allowed to operate during or after a calibration cycle. At least one of the ALCCAL, ALCEN or ALCULOK bits must be set.

## VCO (N) DIVIDER

The 16-bit N divider provides the feedback from the VCO to the PFD. Its divide ratio N may be set to any integer from 32 to 65535, inclusive. Use the ND[15:0] bits found in registers h05 and h06 to directly program the N divide ratio. See the Applications Information section for the relationship between $N$ and the $f_{\text {REF }}, f_{\text {PFD }}, f_{V C O}$ and $f_{R F}$ frequencies.

## OUTPUT (0) DIVIDER

The 3-bit 0 divider can reduce the frequency from the VCO to extend the output frequency range. Its divide ratio 0 may be set to any integer from 1 to 6 , inclusive, outputting a $50 \%$ duty cycle even with odd divide values. Use the

OD[2:0] bits found in register h08 to directly program the 0 divide ratio. See the Applications Information section for the relationship between 0 and the $\mathrm{f}_{\text {REF }}, \mathrm{f}_{\text {PFD }}, \mathrm{f}_{\mathrm{VCO}}$ and $f_{R F}$ frequencies.

## RF OUTPUT BUFFER

The low noise, differential output buffer produces a differential output power of -6 dBm to 3 dBm , settable with bits RFO[1:0] according to Table 10. The outputs may be combined externally, or used individually. Terminate any unused output with a $50 \Omega$ resistor to $\mathrm{V}_{\mathrm{RF}}{ }^{+}$.

Table 10. RFO[1:0] Programming

| RFO[1:0\} | $\mathbf{P}_{\text {RF }}$ (Differential) | $\mathbf{P}_{\text {RF }}$ (Single Ended) |
| :---: | :---: | :---: |
| 0 | -6 dBm | -9 dBm |
| 1 | -3 dBm | -6 dBm |
| 2 | 0 dBm | -3 dBm |
| 3 | 3 dBm | 0 dBm |

Each output is open collector with $136 \Omega$ pull-up resistors to $\mathrm{V}_{\mathrm{RF}}{ }^{+}$, easing impedance matching at high frequencies. See Figure 6 for circuit details and the Applications Information section for matching guidelines. The buffer may be muted with either the OMUTE bit, found in register h02, or by forcing the MUTE input low.


Figure 6. Simplified RF Interface Schematic

## operation

## SERIAL PORT

The SPI-compatible serial port provides control and monitoring functionality. A configurable status output, STAT, gives additional instant monitoring.

## Communication Sequence

The serial bus is comprised of $\overline{\mathrm{CS}}, \mathrm{SCLK}, \mathrm{SDI}$ and SDO. Data transfers to the part are accomplished by the serial bus master device first taking $\overline{\mathrm{CS}}$ low to enable the LTC6946's port. Input data applied on SDI is clocked on the rising edge of SCLK, with all transfers MSB first. The communication burst is terminated by the serial bus master returning $\overline{\mathrm{CS}}$ high. See Figure 7 for details.

Data is read from the part during a communication burst using SDO. Readback may be multidrop (more than one LTC6946 connected in parallel on the serial bus), as SD0 is three-stated ( $\mathrm{Hi}-\mathrm{Z}$ ) when $\overline{\mathrm{CS}}=1$, or when data is not being read from the part. If the LTC6946 is not used in a multidrop configuration, or if the serial port master is not capable of setting the SDO line level between read sequences, it is recommended to attach a high value resistor of greater than 200k between SDO and GND to ensure the line returns to a known level during Hi-Z states. See Figure 8 for details.

## Single Byte Transfers

The serial port is arranged as a simple memory map, with status and control available in 12, byte-wide registers. All data bursts are comprised of at least two bytes. The 7 most significant bits of the first byte are the register address, with an LSB of 1 indicating a read from the part, and LSB of 0 indicating a write to the part. The subsequent byte, or bytes, is data from/to the specified register address. See Figure 9 for an example of a detailed write sequence, and Figure 10 for a read sequence.
Figure 11 shows an example of two write communication bursts. The first byte of the first burst sent from the serial bus master on SDI contains the destination register address (AddrO) and an LSB of "0" indicating a write. The next byte is the data intended for the register at address Addr0. $\overline{\mathrm{CS}}$ is then taken high to terminate the transfer. The first byte of the second burst contains the destination register address (Addr1) and an LSB indicating a write. The next byte on SDI is the data intended for the register at address Addr1. $\overline{\mathrm{CS}}$ is then taken high to terminate the transfer.


Figure 7. Serial Port Write Timing Diagram


Figure 8. Serial Port Read Timing Diagram

## OPERATION

## Multiple Byte Transfers

More efficient data transfer of multiple bytes is accomplished by using the LTC6946's register address autoincrement feature as shown in Figure 12. The serial port master sends the destination register address in the first byte and its data in the second byte as before, but continues sending bytes destined for subsequent registers. Byte 1's address is Addr0+1, Byte 2's address is Addr0+2, and so
on. If the resister address pointer attempts to increment past 11 (hOB), it is automatically reset to 0 .

An example of an auto-increment read from the part is shown in Figure 13. The first byte of the burst sent from the serial bus master on SDI contains the destination register address (Addr0) and an LSB of " 1 " indicating a read. Once the LTC6946 detects a read burst, it takes SDO out of the Hi-Z condition and sends data bytes sequentially,


Figure 9. Serial Port Write Sequence


Figure 10. Serial Port Read Sequence


Figure 11. Serial Port Single Byte Write


Figure 12. Serial Port Auto-Increment Write

## OPERATION



Figure 13. Serial Port Auto-Increment Read
beginning with data from register Addr0. The part ignores all other data on SDI until the end of the burst.

## Multidrop Configuration

Several LTC6946s may share the serial bus. In this multidrop configuration, SCLK, SDI, and SDO are common between all parts. The serial bus master mustuse a separate $\overline{\text { CS }}$ for each LTC6946 and ensure that only one device has $\overline{\mathrm{CS}}$ asserted at any time. It is recommended to attach a high value resistor to SDO to ensure the line returns to a known level during $\mathrm{Hi}-\mathrm{Z}$ states.

## Serial Port Registers

The memory map of the LTC6946 may be found in Table 11, with detailed bitdescriptions found in Table 12. The register address shown in hexadecimal format under the ADDR column is used to specify each register. Each register is denoted as either read-only $(\mathrm{R})$ or read-write (R/W). The register's default value on device power-up or after a reset is shown at the right.
The read-only register at address h00 is used to determine different status flags. These flags may be instantly output on the STAT pin by configuring register h01. See the STAT Output section for more information.
The read-only register at address hOB is a ROM byte for device identification.

Table 11. Serial Port Register Contents

| ADDR | MSB | [6] | [5] | [4] | [3] | [2] | [1] | LSB | R/W | DEFAULT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| h00 | * | * | UNLOCK | ALCHI | ALCLO | LOCK | THI | TLO | R |  |
| h01 | * | * | x[5] | x[4] | x[3] | x[2] | x[1] | x[0] | R/W | h04 |
| h02 | PDALL | PDPLL | PDVCO | PDOUT | PDREFO | MTCAL | OMUTE | POR | R/W | h0E |
| h03 | BD[3] | BD[2] | BD[1] | BD[0] | * | * | RD[9] | $\mathrm{RD}[8]$ | R/W | h30 |
| h04 | RD[7] | $\mathrm{RD}[6]$ | RD[5] | RD[4] | $\mathrm{RD}[3]$ | $\mathrm{RD}[2]$ | RD[1] | $\mathrm{RD}[0]$ | R/W | h01 |
| h05 | ND[15] | ND[14] | ND[13] | ND[12] | ND[11] | ND[10] | ND[9] | ND[8] | R/W | h00 |
| h06 | ND[7] | ND[6] | ND[5] | ND[4] | ND[3] | ND[2] | ND[1] | ND[0] | R/W | hFA |
| h07 | ALCEN | ALCMON | ALCCAL | ALCULOK | * | * | CAL | LKEN | R/W | h21 |
| h08 | BST | FILT[1] | FILT[0] | RFO[1] | RFO[0] | OD[2] | OD[1] | OD[0] | R/W | hF9 |
| h09 | LKWIN[1] | LKWIN[0] | LKCT[1] | LKCT[0] | CP[3] | CP[2] | CP[1] | CP[0] | R/W | h9B |
| h0A | CPCHI | CPCLO | CPMID | CPINV | CPWIDE | CPRST | CPUP | CPDN | R/W | hE4 |
| h0B | REV[2] | REV[1] | REV[0] | PART[4] | PART[3] | PART[2] | PART[1] | PART[0] | R | hxx ${ }^{\dagger}$ |

[^0]
## operation

Table 12. Serial Port Register Bit Field Summary

| BITS | DESCRIPTION | DEFAULT |
| :---: | :---: | :---: |
| ALCCAL | Auto Enable ALC During CAL Operation | 1 |
| ALCEN | Always Enable ALC (Override) | 1 |
| ALCHI | ALC Too Hi Flag |  |
| ALCLO | ALC Too Low Flag |  |
| ALCMON | Enable ALC Monitor for Status Flags Only | 0 |
| ALCULOK | Enable ALC When PLL Unlocked | 0 |
| BD[3:0] | Calibration B Divider Value | h3 |
| BST | REF Buffer Boost Current | 1 |
| CAL | Start VCO Calibration (auto clears) | 0 |
| CP[3:0] | CP Output Current | hB |
| CPCHI | CP Enable Hi Voltage Output Clamp | 1 |
| CPCLO | CP Enable Low Voltage Output Clamp | 1 |
| CPDN | CP Pump Down Only | 0 |
| CPINV | CP Invert Phase | 0 |
| CPMID | CP Bias to Mid-Rail | 1 |
| CPRST | CP Three-State | 1 |
| CPUP | CP Pump Up Only | 0 |
| CPWIDE | CP Extend Pulse Width | 0 |
| FILT[1:0] | REF Input Buffer Filter | h3 |
| LKCT[1:0] | PLL Lock Cycle Count | h1 |
| LKEN | PLL Lock Indicator Enable | 1 |
| LKWIN[1:0] | PLL Lock Indicator Window | h2 |
| LOCK | PLL Lock Indicator Flag |  |
| MTCAL | Mutes Output During Calibration | 1 |
| ND[15:0] | N Divider Value (ND[15:0] > 31) | h00FA |
| OD[2:0] | Output Divider Value (0 < OD[2:0] < 7) | h1 |
| OMUTE | Mutes RF Output | 1 |
| PART[4:0] | Part code (h01 for LTC6946-1, h02 for LTC6946-2, h03 for LTC6946-3, h04 for LTC6946-4 Version) | $\begin{aligned} & \text { h01, h02, } \\ & \text { h03, h04 } \end{aligned}$ |
| PDALL | Full Chip Power Down | 0 |
| PDOUT | Powers Down 0_DIV, RF Output Buffer | 0 |
| PDPLL | Powers Down REF, REFO, R_DIV, PFD, CPUMP, N_DIV | 0 |
| PDREFO | Powers Down REFO | 1 |
| PDVCO | Powers Down VCO, N_DIV | 0 |
| POR | Force Power-On Reset | 0 |
| RD[9:0] | R Divider Value (RD[9:0] > 0) | h001 |
| REV[2:0] | Rev Code |  |
| RFO[1:0] | RF Output Power | h3 |
| THI | CP Clamp High Flag |  |
| TLO | CP Clamp Low Flag |  |
| UNLOCK | PLL Unlock Flag |  |
| x[5:0] | STAT Output OR Mask | h04 |

## STAT Output

The STAT output pin is configured with the $x[5: 0]$ bits of register h01. These bits are used to bit-wise mask, or enable, the corresponding status flags of status register h00, according to Equation 2. The result of this bit-wise Boolean operation is then output on the STAT pin:
STAT = OR (Reg00[5:0] AND Reg01[5:0]) or expanded:

STAT = (UNLOCK AND x[5]) OR
(ALCHI AND x[4]) OR
(ALCLO AND x[3]) OR
(LOCK AND x[2]) OR
(THI AND x[1]) OR
(TLO AND x[0])
For example, if the application requires STAT to go high whenever the ALCHI, ALCLO, or THI flags are set, then x[4], x[3], and x[1] should be set to "1", giving a register value of h1A.

## Block Power-Down Control

The LTC6946's power-down control bits are located in register h02, described in Table 12. Different portions of the device may be powered down independently. Care must be taken with the LSB of the register, the POR (power-on reset) bit. When written to a " 1 ", this bit forces a full reset of the part's digital circuitry to its power-up default state.

## APPLICATIONS INFORMATION

## INTRODUCTION

APLL is a complex feedback system that may conceptually be considered a frequency multiplier. The system multiplies the frequency input at $\mathrm{REF}^{ \pm}$and outputs a higher frequency at RF ${ }^{ \pm}$. The PFD, charge pump, N divider, and external VCO and loop filter form a feedback loop to accurately control the output frequency (see Figure 14). The R and 0 divider are used to set the output frequency resolution.


Figure 14. PLL Loop Diagram

## OUTPUT FREQUENCY

When the loop is locked, the frequency $\mathrm{f}_{\mathrm{Vco}}$ (in Hz) produced at the output of the VCO is determined by the reference frequency, $\mathrm{f}_{\text {REF }}$, and the R and N divider values, given by Equation 3:

$$
\begin{equation*}
f_{V C O}=\frac{f_{\text {REF }} \bullet N}{R} \tag{3}
\end{equation*}
$$

Here, the PFD frequency $f_{\text {PFD }}$ produced is given by the following equation:

$$
\begin{equation*}
f_{P F D}=\frac{f_{\text {REF }}}{R} \tag{4}
\end{equation*}
$$

and $f_{v c o}$ may be alternatively expressed as:

$$
f_{V C O}=f_{P F D} \bullet N
$$

The output frequency $f_{\text {RF }}$ produced at the output of the 0 divider is given by Equation 5:

$$
\begin{equation*}
f_{R F}=\frac{f_{V C O}}{0} \tag{5}
\end{equation*}
$$

Using the above equations, the outputfrequency resolution $\mathrm{f}_{\text {STEP }}$ produced by a unit change in N is given by Equation 6:

$$
\begin{equation*}
\mathrm{f}_{\mathrm{STEP}}=\frac{\mathrm{f}_{\mathrm{REF}}}{\mathrm{R} \bullet 0} \tag{6}
\end{equation*}
$$

## LOOP FILTER DESIGN

A stable PLL system requires care in selecting the external loop filter values. The Linear Technology PLLWizard application, available from www.linear.com, aids in design and simulation of the complete system.

The loop design should use the following algorithm:

1. Determine the output frequency, $f_{R F}$, and frequency step size, $f_{\text {STEP }}$, based on application requirements. Using Equations $3,4,5$ and 6 , change $f_{\text {REF }}, N, R$, and 0 until the application frequency constraints are met. Use the minimum R value that still satisfies the constraints. Then calculate B using Equation 1 and Table 7.
2. Select the open-loop bandwidth, BW, constrained by $f_{P F D}$. A stable loop requires that BW is less than $f_{\text {PFD }}$ by at least a factor of 10 .
3. Select loop filter component $R_{Z}$ and charge pump current $I_{C P}$ based on BW and the VCO gain factor, $K_{V C O}$. BW (in Hz ) is approximated by the following equation:

$$
\begin{equation*}
\mathrm{BW} \cong \frac{\mathrm{I}_{\mathrm{CP}} \cdot \mathrm{R}_{\mathrm{Z}} \cdot \mathrm{~K}_{\mathrm{VCO}}}{2 \cdot \pi \cdot \mathrm{~N}} \tag{7}
\end{equation*}
$$

or

$$
\mathrm{R}_{\mathrm{Z}}=\frac{2 \cdot \pi \cdot \mathrm{BW} \cdot \mathrm{~N}}{\mathrm{I}_{\mathrm{CP}} \cdot \mathrm{~K}_{\mathrm{VCO}}}
$$

where $K_{V C O}$ is in $H z / V, I_{C P}$ is in Amps, and $R_{Z}$ is in Ohms.
$\mathrm{K}_{\mathrm{V} C O}$ is obtained from the VCO tuning sensitivity in the Electrical Characteristics. Use $\mathrm{I}_{\mathrm{CP}}=11.2 \mathrm{~mA}$ to lower inband noise unless component values force a lower setting.

## APPLICATIONS INFORMATION

4. Select loop filter components $C_{I}$ and $C_{P}$ based on BW and $R_{z}$. A reliable loop can be achieved by using the following equations for the loop capacitors (in Farads):

$$
\begin{align*}
& C_{I}=\frac{3.5}{2 \cdot \pi \cdot B W \cdot R_{Z}}  \tag{8}\\
& C_{P}=\frac{1}{7 \cdot \pi \cdot B W \cdot R_{Z}} \tag{9}
\end{align*}
$$

## DESIGN AND PROGRAMMING EXAMPLE

This programming example uses the DC1705A with the LTC6946-3. Assume the following parameters of interest:
$\mathrm{f}_{\text {REF }}=20 \mathrm{MHz}$ at 7 dBm into $50 \Omega$
$\mathrm{f}_{\text {STEP }}=125 \mathrm{kHz}$
$f_{\text {RF }}=2.4 \mathrm{GHz}$
From the Electrical Characteristics table:

$$
\begin{aligned}
& f_{V C O}=3.840 \mathrm{GHz} \text { to } 5.790 \mathrm{GHz} \\
& \mathrm{~K}_{\mathrm{VCO}}=4.0 \% \mathrm{~Hz} / \mathrm{V} \text { to } 6.0 \% \mathrm{~Hz} / \mathrm{V}
\end{aligned}
$$

## Determining Divider Values

Following the Loop Filter Design algorithm, first determine all the divider values. Using Equations 2, 3, 4 and 5 calculate the following values:

$$
\begin{aligned}
& 0=2 \\
& R=20 \mathrm{MHz} /(125 \mathrm{kHz} \cdot 2)=80 \\
& f_{\text {PFD }}=250 \mathrm{kHz} \\
& \mathrm{~N}=2 \cdot 2.4 \mathrm{GHz} / 250 \mathrm{kHz}=19200 \\
& \mathrm{f}_{\mathrm{VCO}}=4.8 \mathrm{GHz}
\end{aligned}
$$

Also, from Equation 1 or Table 7 determine B:

$$
\mathrm{B}=8 \text { and } \mathrm{BD}[3: 0]=0
$$

The next step in the algorithm is to determine the openloop bandwidth. BW should be at least $10 \times$ smaller than $f_{\text {PFD }}$. Wider loop bandwidths could have lower integrated phase noise, depending on the VCO phase noise signature, while narrower bandwidths will likely have lower spurious
power. Use a factor of 15 for this design example:

$$
\mathrm{BW}=\frac{250 \mathrm{kHz}}{15}=16.7 \mathrm{kHz}
$$

## Loop Filter Component Selection

Now set loop filter resistor, Rz, and charge pump current, $I_{\text {cP. }}$. Because the K ${ }_{v C O}$ varies over the VCO's frequency range, using the $K_{v c 0}$ geometric mean gives good results. Using an $I_{C P}$ of $11.2 \mathrm{~mA}, \mathrm{R}_{Z}$ is determined:

$$
\begin{aligned}
& \mathrm{K}_{\mathrm{VCO}}=4.8 \cdot 10^{9} \cdot \sqrt{0.04 \cdot 0.06}=235 \mathrm{MHz} / \mathrm{V} \\
& \mathrm{R}_{\mathrm{Z}}=\frac{2 \cdot \pi \cdot 16.7 \mathrm{k} \cdot 19200}{11.2 \mathrm{~m} \cdot 235 \mathrm{M}} \\
& \mathrm{R}_{\mathrm{Z}}=765 \Omega
\end{aligned}
$$

Now calculate $\mathrm{C}_{\mid}$and $\mathrm{C}_{\mathrm{P}}$ from Equations 7 and 8 :

$$
\begin{aligned}
& \mathrm{C}_{I}=\frac{3.5}{2 \cdot \pi \cdot 16.7 \mathrm{k} \cdot 765}=44 \mathrm{nF} \\
& \mathrm{C}_{P}=\frac{1}{7 \cdot \pi \cdot 16.7 \mathrm{k} \cdot 765}=3.6 \mathrm{nF}
\end{aligned}
$$

## Status Output Programming

This example will use the STAT pin to alert the system whenever the LTC6946 generates a fault condition. Program $x[5], x[4], x[3], x[1], x[0]=1$ to force the STAT pin high whenever any of the UNLOCK, ALCHI, ALCLO, THI or TLO flags asserts:
Reg01 = h3B

## Power Register Programming

For correct PLL operation all internal blocks should be enabled, but PDREFO should be set if the REFO pin is not being used. OMUTE may remain asserted (or the MUTE pin held low) until programming is complete. For PDREFO = 1 and OMUTE = $1:$

$$
\text { Reg02 }=\mathrm{h} 0 \mathrm{~A}
$$

## APPLICATIONS INFORMATION

## Divider Programming

Program registers Reg03 to Reg06 with the previously determined $B, R$ and $N$ divider values.

$$
\begin{aligned}
& \text { Reg03 }=\text { h00 } \\
& \text { Reg04 }=\text { h50 } \\
& \text { Reg05 }=\text { h } 4 \mathrm{~B} \\
& \text { Reg06 }=\text { h00 }
\end{aligned}
$$

## VCO ALC and Calibration Programming

Now that all the divider registers are programmed, and assuming that the reference frequency is stable at $\mathrm{REF}^{ \pm}$, calibrate the VCO. Set the ALC options (ALCMON = 1, ALCCAL $=1$ ) and the lock enable bit (LKEN $=1$ ) at the same time:
Reg07 = h63

The LTC6946 will now calibrate its VCO. The ALC will only be active during the calibration cycle, but the ALCHI and ALCLO status conditions will be monitored.

## Reference Input Settings and Output Divider Programming

From Table 1, FILT = 1 for a 20MHz reference frequency. Next, convert 7dBm into VP-p. For a CW tone, use the following equation with $R=50$ :

$$
\begin{equation*}
V_{P-P} \cong \sqrt{R} \cdot 10^{(d B m-21) / 20} \tag{10}
\end{equation*}
$$

This gives $V_{P-P}=1.41 \mathrm{~V}$, and, according to Table 2, set $B S T=1$.

Now program Reg08, assuming maximum $\mathrm{RF}^{ \pm}$output power (RFO[1:0] = 3 according to Table 9) and OD[2:0] = 2 :

$$
\operatorname{Reg} 08=\mathrm{hBA}
$$

## Lock Detect and Charge Pump Current Programming

Next, determine the lock indicator window from fPFD. From Table 3, LKWIN[1:0] = 3 for a tLWw of 90ns. The LTC6946 will consider the loop "locked" as long as the phase coincidence at the PFD is within $8^{\circ}$, as calculated:

$$
\text { phase }=360^{\circ} \bullet \text { t LWW } \bullet f_{\text {PFD }}=360 \bullet 90 \mathrm{n} \bullet 250 \mathrm{k} \cong 8^{\circ}
$$

LKWIN[1:0] may be set to a smaller value to be more conservative. However, the inherent phase noise of the loop could cause false "unlocks" for too small a value.

Choosing the correct LOKCNT depends upon the ratio of the bandwidth of the loop to the PFD frequency (BW/fpFD). Smaller ratios dictate larger LOKCNT values. A LOKCNT value of 128 will work for our ratio of $1 / 15$. From Table 4, LKCNT[1:0] = 1 for 128 counts.

Using Table 5 with the previously selected $\mathrm{I}_{\mathrm{CP}}$ of 11.2 mA , gives $C P[3: 0]=11(h B)$. This is enough information to program Reg09:
Reg09 = hDB

## Charge Pump Function Programming

This example uses the additional voltage clamp features to allow us to monitor fault conditions by setting $\mathrm{CPCHI}=1$ and CPCLO $=1$. If something occurs and the system can no longer lock to its intended frequency, the charge pump output will move toward either GND or $\mathrm{VCP}^{+}$, thereby setting either the TLO or THI status flags, respectively. Disable all the other charge pump functions (CPMID, CPINV, CPRST, CPUP and CPDN) to allow the loop to lock:
RegOA = hCO

The loop should now lock. Now unmute the output by setting OMUTE $=0$ (assumes the MUTE pin is high):
Reg02 = h08

## REFERENCE SOURCE CONSIDERATIONS

A high quality signal must be applied to the REF ${ }^{ \pm}$inputs as they provide the frequency reference to the entire PLL. As mentioned previously, to achieve the part's in-band phase noise performance, apply a CW signal of at least 6 dBm into $50 \Omega$, or a square wave of at least 0.5 V p-p with slew rate of at least $40 \mathrm{~V} / \mu \mathrm{s}$.
The LTC6946 may be driven single ended to CMOS levels (greater than 2.7Vp-p ). Apply the reference signal directly without a DC-blocking capacitor at REF ${ }^{+}$, and bypass REFto GND with a 47pF capacitor. The BST bit must also be set to " 0 ", according to guidelines given in Table 2.

## APPLICATIONS InFORMATION

The LTC6946 achieves an in-band normalized phase noise floor of $-226 \mathrm{dBc} / \mathrm{Hz}$ (typical). To calculate its equivalent input phase noise floor $L_{M(I N)}$, use the following Equation 11:

$$
\begin{equation*}
\mathrm{L}_{\mathrm{M}(\mathrm{IN})}=-226+10 \cdot \log _{10}\left(f_{\mathrm{REF}}\right) \tag{11}
\end{equation*}
$$

For example, using a 10 MHz reference frequency gives an input phase noise floor of $-156 \mathrm{dBc} / \mathrm{Hz}$. The reference frequency source's phase noise must be at least 3dB better than this to prevent limiting the overall system performance.

## IN-BAND OUTPUT PHASE NOISE

The in-band phase noise produced at $f_{\text {RF }}$ may be calculated by using Equation 12.

$$
\begin{align*}
& \mathrm{L}_{\mathrm{M}(O U T)}=-226+10 \cdot \log _{10}\left(\mathrm{f}_{\mathrm{PFD}}\right)  \tag{12}\\
& \quad+20 \cdot \log _{10}\left(\frac{\mathrm{f}_{\mathrm{RF}}}{f_{\text {PFD }}}\right)
\end{align*}
$$

or

$$
\begin{aligned}
& \mathrm{L}_{\mathrm{M}(\mathrm{OUT})}=-226+10 \bullet \log _{10}\left(\mathrm{f}_{\mathrm{PFD}}\right) \\
& \quad+20 \bullet \log _{10}\left(\frac{\mathrm{~N}}{0}\right)
\end{aligned}
$$

As can be seen, for a given PFD frequency fPFD, the output in-band phase noise increases at a 20dB-per-decade rate with the $N$ divider count. So, for a given output frequency $f_{\text {RF }}, f_{\text {PFD }}$ should be as large as possible (or $N$ should be as small as possible) while still satisfying the application's frequency step size requirements.

## OUTPUT PHASE NOISE DUE TO 1/f NOISE

In-band phase noise at very low offset frequencies may be influenced by the LTC6946's 1/f noise, depending upon $f_{\text {PFD }}$. Use the normalized in-band 1/f noise of $-274 \mathrm{dBc} /$ Hz with Equation 13 to approximate the output 1/f phase noise at a given frequency offset foFFSET.

$$
\begin{align*}
\mathrm{L}_{\mathrm{M}(\text { OUT- } 1 / \mathrm{f})}\left(\mathrm{f}_{\text {OFFSET }}\right)= & -274+20 \cdot \log _{10}\left(\mathrm{f}_{\mathrm{RF}}\right)  \tag{13}\\
& -10 \cdot \log _{10}\left(\mathrm{f}_{\text {OFFSET }}\right)
\end{align*}
$$

Unlike the in-band noise floor $\mathrm{L}_{\text {M(OUT) }}$, the $1 / f$ noise $\mathrm{L}_{\mathrm{M}(\text { OUT } 1 / f)}$ does not change with $\mathrm{f}_{\text {PFD }}$, and is not constant
over offset frequency. See Figure 15 for an example of in-band phase noise for fpFD equal to 3 MHz and 100 MHz . The total phase noise will be the summation of LM(OUT) and $\mathrm{L}_{\text {m(OUT 1/f) }}$.


6945 F15
Figure 15. Theoretical In-Band Phase Noise, $\mathrm{f}_{\mathrm{RF}}=\mathbf{2 5 0 0 M H z}$

## RF OUTPUT MATCHING

The RF ${ }^{ \pm}$outputs may be used in either single-ended or differential configurations. Using both RFoutputs differentially will result in approximately 3dB more output power than single ended. Impedance matching to an external load in both cases requires external chokes tied to $\mathrm{V}_{\mathrm{RF}}{ }^{+}$. Measured $\mathrm{RF}^{ \pm}$s-parameters are shown below in Table 13 to aid in the design of impedance matching networks.

Table 13. Single-Ended RF Output Impedance

| FREQUENCY (MHZ) | IMPEDANCE (Ohms) | S11 (dB) |
| :---: | :---: | :---: |
| 500 | $102.8-\mathrm{j} 49.7$ | -6.90 |
| 1000 | $70.2-\mathrm{j} 60.1$ | -6.53 |
| 1500 | $52.4-\mathrm{j} 56.2$ | -6.35 |
| 2000 | $43.6-\mathrm{j} 49.2$ | -6.58 |
| 2500 | $37.9-\mathrm{j} 39.6$ | -7.34 |
| 3000 | $32.7-\mathrm{j} 28.2$ | -8.44 |
| 3500 | $27.9-\mathrm{j} 17.8$ | -8.99 |
| 4000 | $24.3-\mathrm{j} 9.4$ | -8.72 |
| 4500 | $22.2-\mathrm{j} 3.3$ | -8.26 |
| 5000 | $21.6+\mathrm{j} 1.9$ | -8.02 |
| 5500 | $21.8+\mathrm{j} 6.6$ | -7.91 |
| 6000 | $23.1+\mathrm{j} 11.4$ | -8.09 |
| 6500 | $25.7+\mathrm{j} 16.9$ | -8.38 |
| 7000 | $29.3+\mathrm{j} 23.0$ | -8.53 |
| 7500 | $33.5+\mathrm{j} 28.4$ | -8.56 |
| 8000 | $37.9+\mathrm{j} 32.6$ | -8.64 |

## APPLICATIONS IIFORMATION

Single-ended impedance matching is accomplished using the circuit of Figure 16, with component values found in Table 14. Using smaller inductances than recommended can cause phase noise degradation, especially at lower center frequencies.

Table 14. Suggested Single-Ended Matching Component Values

| $\mathbf{f}_{\text {RF }}(\mathbf{M H z})$ | $\mathbf{L}_{\boldsymbol{C}}(\mathbf{n H})$ | $\mathbf{C}_{S}(\mathbf{p F})$ |
| :---: | :---: | :---: |
| 350 to 1500 | 180 | 270 |
| 1000 to 5800 | 68 | 100 |

Return Ioss measured on the DC1705 using the above component values is shown in Figure 17. A broadband match is achieved using an ( $\mathrm{L}_{\mathrm{C}}, \mathrm{C}_{S}$ ) of either ( $68 \mathrm{nH}, 100 \mathrm{pF}$ ) or (180nH, 270pF). However, for maximum output power and best phase noise performance, use the recommended component values of Table 13. $L_{C}$ should be a wirewound inductor selected for maximum $Q$ factor and SRF, such as the Coilcraft HP series of chip inductors.

The LTC6946's differential RFº outputs may be combined using an external balun to drive a single-ended load. The advantages are approximately 3dB more output powerthan each output individually and better 2nd order harmonic performance.

For lower frequencies, transmission line (TL) baluns such as the M/A-COM MABACT0065 and the TOKO \#617DB1673 provide good results. At higher frequencies, surface mount (SMT) baluns such as those produced by TDK, Anaren, and Johanson Technology, can be attractive alternatives. See Table 15 for recommended balun part numbers versus frequency range.


Figure 16. Single-Ended Output Matching Schematic


Figure 17. Single-Ended Return Loss
The listed SMT baluns contain internal chokes to bias RF ${ }^{ \pm}$ and also provide input-to-output DC isolation. The pin denoted as GND or DC FEED should be connected to the $\mathrm{V}_{\mathrm{RF}}{ }^{+}$voltage. Figure 18 shows a surface mount balun's connections with a DC FEED pin.

Table 15. Suggested Baluns

| $\mathrm{f}_{\text {RF }}$ (MHz) | PART NUMBER | MANUFACTURER | TYPE |
| :---: | :---: | :---: | :---: |
| 350 to 900 | \#617DB-1673 | TOKO | TL |
| 400 to 600 | HHM1589B1 | TDK | SMT |
| 600 to 1400 | BD0810J50200 | Anaren | SMT |
| 600 to 3000 | MABACT0065 | M/A-COM | TL |
| 1000 to 2000 | HHM1518A3 | TDK | SMT |
| 1400 to 2000 | HHM1541E1 | TDK | SMT |
| 1900 to 2300 | 2450BL15B100E | Johanson | SMT |
| 2000 to 2700 | HHM1526 | TDK | SMT |
| 3700 to 5100 | HHM1583B1 | TDK | SMT |
| 4000 to 6000 | HHM1570B1 | TDK | SMT |

The listed TL baluns do not provide input-to-output DC isolation and must be AC coupled at the output. Figure 18 displays $\mathrm{RF}^{ \pm}$connections using these baluns.

## APPLICATIONS INFORMATION



Figure 18. Example SMT Balun Connection


Figure 19. Example TL Balun Connection

## SUPPLY BYPASSING AND PCB LAYOUT GUIDELINES

Care must be taken when creating a PCB layout to minimize power supply decoupling and ground inductances. All power supply $\mathrm{V}^{+}$pins should be bypassed directly to the ground plane using a $0.1 \mu \mathrm{~F}$ ceramic capacitor as close to the pin as possible. Multiple vias to the ground plane should be used for all ground connections, including to the power supply decoupling capacitors.

The package's exposed pad is a ground connection, and must be soldered directly to the PCB land. The PCB land pattern should have multiple thermal vias to the ground plane for both low ground inductance and also low thermal resistance (see Figure 20 for an example). See QFN Package Users Guide, page 8, on Linear Technology website's Packaging Information page for specific recommendations concerning land patterns and land via solder masks. A link is provided below.
http://www.linear.com/designtools/packaging


Figure 20. Example Exposed Pad Land Pattern

## REFERENCE SIGNAL ROUTING, SPURIOUS AND PHASE NOISE

The charge pump operates at the PFD's comparison frequency $\mathrm{f}_{\text {PFD }}$. The resultant output spurious energy is small and is further reduced by the loop filter before it modulates the VCO frequency.

However, improper PCB layout can degrade the LTC6946's inherent spurious performance. Care must be taken to prevent the reference signal $f_{\text {REF }}$ from coupling onto the VCO's tune line, or into other loop filter signals. Example suggestions are the following.

1. Do not share power supply decoupling capacitors between same voltage power supply pins.
2. Use separate ground vias for each power supply decoupling capacitor, especially those connected to $\mathrm{V}_{\text {REF }}{ }^{+}$, $V_{C P^{+}}$, and $V_{V C O}{ }^{+}$.
3. Physically separate the reference frequency signal from the loop filter and VCO.
4. Do not place a trace between the $\mathrm{CM}_{\mathrm{A}}, \mathrm{CM}_{\mathrm{B}}$ and $\mathrm{CM}_{\mathrm{C}}$ pads underneath the package as worse phase noise could result.

## APPLICATIONS INFORMATION

LTC6946-2 Driving a Modulator


## PACKAGE DESCRIPTION

Please refer to http://www.linear.com/designtools/packaging/ for the most recent package drawings.

UFD Package
28-Lead Plastic QFN ( $4 \mathrm{~mm} \times 5 \mathrm{~mm}$ )
(Reference LTC DWG \# 05-08-1712 Rev B)


NOTE:

1. DRAWING PROPOSED TO BE MADE A JEDEC PACKAGE OUTLINE MO-220 VARIATION (WXXX-X)
2. DRAWING NOT TO SCALE
3. ALL DIMENSIONS ARE IN MILLIMETERS
4. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE

MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.15mm ON ANY SIDE
5. EXPOSED PAD SHALL BE SOLDER PLATED
6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON THE TOP AND BOTTOM OF PACKAGE

## REVISION HISTORY

$\left.\begin{array}{c|c|l|c}\hline \text { REV } & \text { DATE } & \text { DESCRIPTION } & \text { PAGE NUMBER } \\ \hline \text { A } & 11 / 11 & \begin{array}{l}\text { Add IoL and remove Max value, remove Max value for IOH } \\ \text { Revise values on Block Diagram }\end{array} & 4 \\ \hline \text { B } & 03 / 15 & \begin{array}{l}\text { Added LTC6946-4. } \\ \text { Changed operating core temperature to operating junction temperature. } \\ \text { Updated power supply currents. } \\ \text { Updated VCO calibration. }\end{array} & \text { All pages } \\ & & 2\end{array}\right] 5$

## TYPICAL APPLICATION

LTC6946-2 Driving a Passive Downconverting Mixer


## RELATED PARTS

| PART NUMBER | DESCRIPTION | COMMENTS |
| :---: | :---: | :---: |
| LTC6945 | Ultralow Noise and Spurious Integer-N Synthesizer | 350MHz to 6GHz, $-226 \mathrm{dBc} / \mathrm{Hz}$ Normalized In-Band Phase Noise Floor |
| LTC6947 | Ultralow Noise and Spurious Fractional-N Synthesizer | 350 MHz to 6GHz, $-226 \mathrm{dBc} / \mathrm{Hz}$ Normalized In-Band Phase Noise Floor |
| LTC6948 | Ultralow Noise and Spurious Frac-N Synthesizer with VCO | 370 MHz to 6.39GHz, $-226 \mathrm{dBc} / \mathrm{Hz}$ Normalized In-Band Phase Noise Floor |
| LTC6950 | Low Phase Noise and Spurious Integer-N PLL Core with Five Output Clock Distribution and EZSync | 1.4GHz Max VCO Frequency, Additive Jitter <20fsRMS, $-226 \mathrm{dBc} / \mathrm{Hz}$ Normalized In-Band Phase Noise Floor |
| LTC6957 | Low Phase Noise, Dual Output Buffer/Driver/Logic Converter | Optimized Conversion of Sine Waves to Logic Levels, LVPECL/LVDS/CMOS |
| LTC2000 | 16-/14-/11-Bit 2.5Gsps DAC | Superior 80dBc SFDR at 70MHz Output, 40mA Nominal Drive and High Linearity |
| LTC5569 | Broadband Dual Mixer | 300MHz to 4GHz, 26.8dBm IIP3, 2dB Gain, 11.7dB NF, 600mW Power |
| LTC5588-1 | Ultrahigh OIP3 I/Q Modulator | 200 MHz to 6GHz, 31dBm OIP3, -160.6dBm/Hz Noise Floor |
| LT®5575 | Direct Conversion I/Q Demodulator | 800MHz to 2.7GHz, 22.6dBm IIP3, 60dBm IIP2, 12.7dB NF |


[^0]:    *unused $\begin{aligned} & \text { tvaries depending on version }\end{aligned}$

